



Parameter	Rating	Units
AC Operating Voltage	260	V <sub>rms</sub>
Load Current	500	mA <sub>rms</sub>
On-State Voltage Drop (I <sub>L</sub> =500mA <sub>rms</sub> )	1.4	V <sub>rms</sub>

### Features

- Load Current up to 0.5A<sub>rms</sub>
- Blocking Voltages up to 600V<sub>P</sub>
- 5mA Sensitivity
- Zero-Crossing Detection
- DC Control, AC Output
- Optically Isolated
- TTL and CMOS Compatible
- Low EMI and RFI Generation
- High Noise Immunity
- VDE compatible
- Machine Insertable, Wave Solderable

### Applications

- Programmable Control
- Process Control
- Power Control Panels
- Remote Switching
- Gas Pump Electronics
- Contactors
- Large Relays
- Solenoids
- Motors
- Heaters

### Description

The PM1206 is an AC Solid State Switch using optical coupling with dual power SCR outputs to produce an alternative to optocoupler and Triac circuits. The PM1206 switches are robust enough to provide a blocking voltage of up to 600V<sub>P</sub>. In addition, tightly controlled zero-cross circuitry ensures switching of AC loads without the generation of transients. The input and output circuits are optically coupled to provide 3750V<sub>rms</sub> of isolation and noise immunity between control and load circuits. As a result, the PM1206 is well suited for industrial environments where electromagnetic interference could disrupt the operation of electromechanical relays.

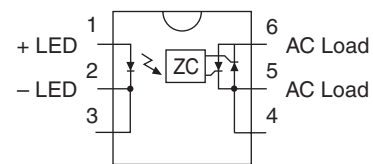
### Approvals

- UL Recognized Component: UL 508 File E69938
- CSA Certified Component: File 043639

### Ordering Information

Part #	Description
PM1206	6-Lead DIP (50/Tube)
PM1206S	6-Lead Surface Mount (50/Tube)
PM1206STR	6-Lead Surface Mount (1000/Reel)

### Pin Configuration



**Absolute Maximum Ratings @ 25°C**

Parameter	Min	Max	Units
Blocking Voltage	-	600	V <sub>P</sub>
Reverse Input Voltage	-	5	V
Input Control Current	-	100	mA
Peak (10ms)	-	1	A
Input Power Dissipation <sup>1</sup>	-	150	mW
Total Package Dissipation <sup>2</sup>	-	800	mW
Isolation Voltage, Input to Output	3750	-	V <sub>rms</sub>
Operational Temperature	-40	+85	°C
Storage Temperature	-40	+125	°C

*Absolute Maximum Ratings are stress ratings. Stresses in excess of these ratings can cause permanent damage to the device. Functional operation of the device at conditions beyond those indicated in the operational sections of this data sheet is not implied.*

<sup>1</sup> Derate linearly 1.33 mW / °C

<sup>2</sup> Derate linearly 6.67 mW / °C

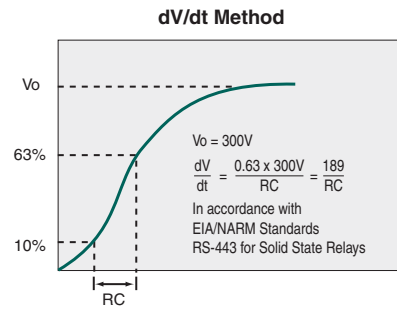
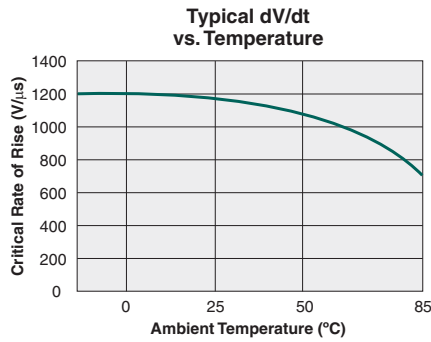
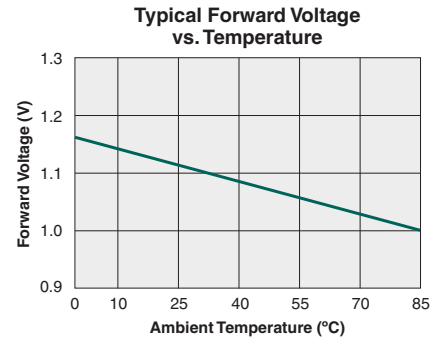
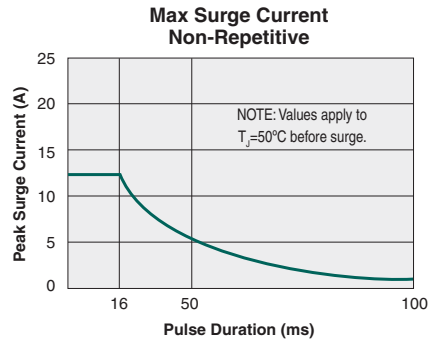
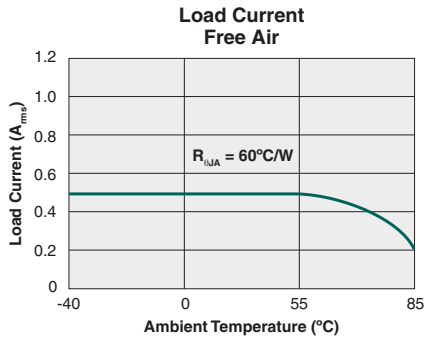
**Electrical Characteristics @ 25°C**

Parameter	Conditions	Symbol	Min	Typ	Max	Units
<b>Output Characteristics</b>						
AC Operating Voltage	I <sub>F</sub> =5mA	V <sub>OP</sub>	20	-	260	V <sub>rms</sub>
Load Current (Continuous)	V <sub>L</sub> =120-240VAC	I <sub>L</sub>	0.005	-	0.5	A <sub>rms</sub>
Maximum Surge Current	t <sub>≤</sub> 16ms	I <sub>PEAK</sub>	-	-	12	A
Off-State Leakage Current	V <sub>L</sub> =600V <sub>DC</sub>	I <sub>LEAK</sub>	-	-	1	mA
On-State Voltage Drop	I <sub>L</sub> =0.5A <sub>rms</sub>	-	-	-	1.4	V <sub>rms</sub>
Critical Rate of Rise	-	dV/dt	1000	1200	-	V/μs
Switching Speeds						
Turn-On	I <sub>F</sub> =5mA	t <sub>on</sub>	-	-	0.5	Cycles
Turn-Off		t <sub>off</sub>	-	-	0.5	
Zero-Cross Turn-On Voltage <sup>1</sup>	1 <sup>st</sup> half-cycle	-	-	2	5	V
	Subsequent half-cycle	-	-	-	1	V
Operating Frequency	-	-	20	-	500	Hz
Load Power Factor for Guaranteed Turn-On <sup>2</sup>	-	PF	0.25	-	-	-
Capacitance Input-To-Output	-	C <sub>I/O</sub>	-	3	-	pF
<b>Input Characteristics</b>						
Input Control Current						
For Normal Environment	-	I <sub>F</sub>	-	-	5	mA
For High Noise Environment	-		-	-	10	
Input Voltage Drop	I <sub>F</sub> =5mA	V <sub>F</sub>	0.9	1.2	1.4	V
Input Dropout Voltage	-	-	0.8	-	-	V
Reverse Input Current	V <sub>R</sub> =5V	I <sub>R</sub>	-	-	10	μA

<sup>1</sup> Zero Cross 1<sup>st</sup> half-cycle @ < 100Hz.

<sup>2</sup> Snubber circuits may be required at low power factors.

**PERFORMANCE DATA\***



\*The Performance data shown in the graphs above is typical of device performance. For guaranteed parameters not indicated in the written specifications, please contact our application department.

**Manufacturing Information**

**Moisture Sensitivity**



All plastic encapsulated semiconductor packages are susceptible to moisture ingress. IXYS Integrated Circuits Division classified all of its plastic encapsulated devices for moisture sensitivity according to the latest version of the joint industry standard, **IPC/JEDEC J-STD-020**, in force at the time of product evaluation. We test all of our products to the maximum conditions set forth in the standard, and guarantee proper operation of our devices when handled according to the limitations and information in that standard as well as to any limitations set forth in the information or standards referenced below.

Failure to adhere to the warnings or limitations as established by the listed specifications could result in reduced product performance, reduction of operable life, and/or reduction of overall reliability.

This product carries a **Moisture Sensitivity Level (MSL) rating** as shown below, and should be handled according to the requirements of the latest version of the joint industry standard **IPC/JEDEC J-STD-033**.

Device	Moisture Sensitivity Level (MSL) Rating
PM1206	MSL 1

**ESD Sensitivity**



This product is **ESD Sensitive**, and should be handled according to the industry standard **JESD-625**.

**Reflow Profile**

This product has a maximum body temperature and time rating as shown below. All other guidelines of **J-STD-020** must be observed.

Device	Maximum Temperature x Time
PM1206	250°C for 30 seconds

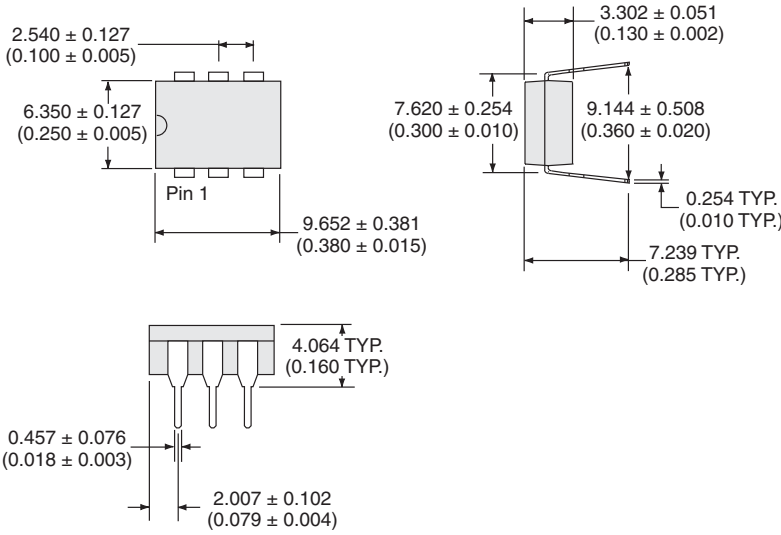
**Board Wash**

IXYS Integrated Circuits Division recommends the use of no-clean flux formulations. However, board washing to remove flux residue is acceptable. Since IXYS Integrated Circuits Division employs the use of silicone coating as an optical waveguide in many of its optically isolated products, the use of a short drying bake could be necessary if a wash is used after solder reflow processes. Chlorine- or Fluorine-based solvents or fluxes should not be used. Cleaning methods that employ ultrasonic energy should not be used.

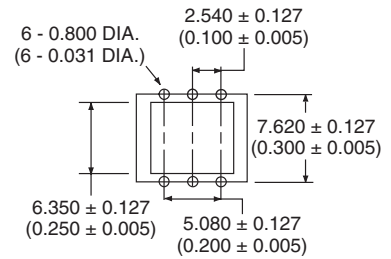


**Mechanical Dimensions**

**PM1206**

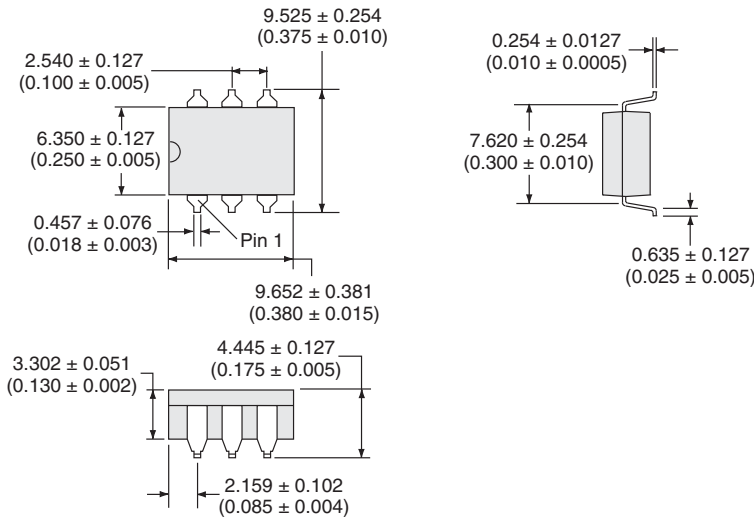


**PCB Hole Pattern**

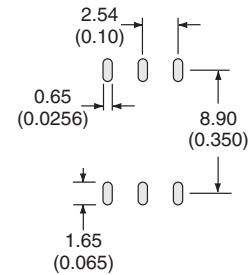


Dimensions  
mm  
(inches)

**PM1206S**

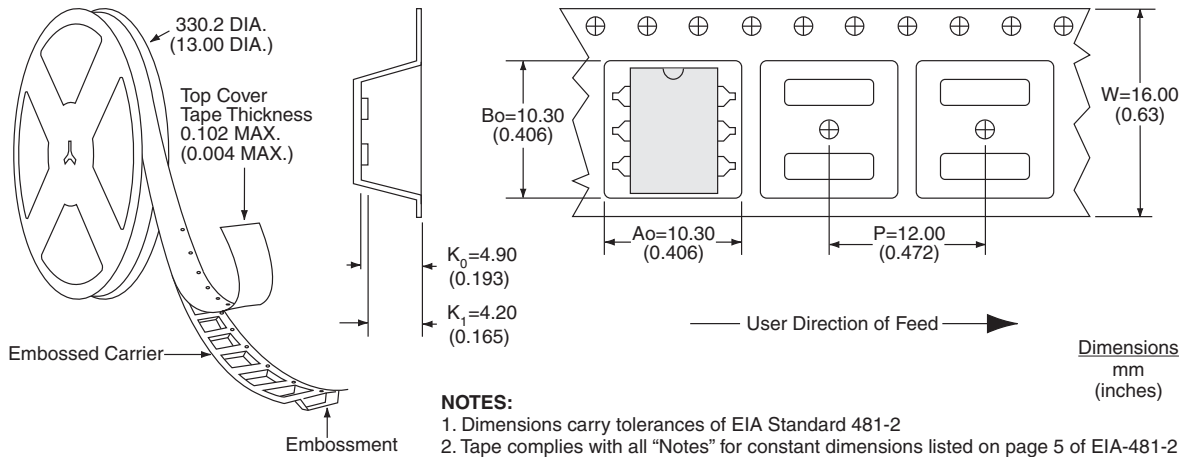


**PCB Land Pattern**



Dimensions  
mm  
(inches)

**PM1206STR Tape & Reel**



**For additional information please visit our website at: [www.ixysic.com](http://www.ixysic.com)**

IXYS Integrated Circuits Division makes no representations or warranties with respect to the accuracy or completeness of the contents of this publication and reserves the right to make changes to specifications and product descriptions at any time without notice. Neither circuit patent licenses nor indemnity are expressed or implied. Except as set forth in IXYS Integrated Circuits Division's Standard Terms and Conditions of Sale, IXYS Integrated Circuits Division assumes no liability whatsoever, and disclaims any express or implied warranty, relating to its products including, but not limited to, the implied warranty of merchantability, fitness for a particular purpose, or infringement of any intellectual property right.

The products described in this document are not designed, intended, authorized or warranted for use as components in systems intended for surgical implant into the body, or in other applications intended to support or sustain life, or where malfunction of IXYS Integrated Circuits Division's product may result in direct physical harm, injury, or death to a person or severe property or environmental damage. IXYS Integrated Circuits Division reserves the right to discontinue or make changes to its products at any time without notice.